## Solderable AlGaAs Flip Chip PIN

#### **Features**

- Low Series Resistance
- Ultra Low Capacitance
- Millimeter Wave Switching & Cutoff Frequency
- Useable up to 70 GHz
- 2 Nanosecond Switching Speed
- Can be Driven by a Buffered TTL
- Silicon Nitride Passivation
- Polyimide Scratch Protection
- RoHS Compliant

#### Description

The MADP-000907-14020 is a solderable, flip-chip Aluminum Gallium Arsenide (AlGaAs) PIN diode. It is fabricated with MOCVD grown epitaxy using a process and design that optimizes device to device uniformity and produces extremely low parasitics. The diode exhibits an exceptionally low RC product (0.1 ps) and a 2-3 ns switching speed. The chips are fully passivated with silicon nitride and have an added BCB polymer layer for scratch protection. The BCB protective coating prevents damage to the diode junction area and anode air-bridge during handling and assembly.

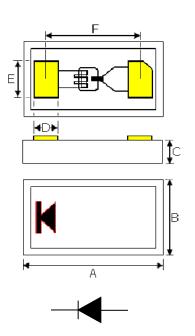
The ultra low capacitance of the MADP-000907-14020 allows for operation at millimeter wave frequencies for RF switches and phase shifter applications. The diode is designed to be used in pulsed or CW applications, where single digit ns switching speed is required. The low capacitance of the PIN diode makes it ideal for use in many microwave multi-throw switch assemblies, where the series capacitance of each "off" port adversely loads the input and affects VSWR.

### **Ordering Information**

Part Number	Package
MADP-000907-14020W	Waffle Pack
MADP-000907-14020P	Tape and Reel

\* Restrictions on Hazardous Substances, European Union Directive 2011/65/EU.

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1. Backside metal: 0.2 µm gold over 4 µm nickel.

2. Yellow hatched areas indicate backside ohmic gold contacts.

### **Outline Dimension**

DIM	INCHES		ММ		
DIM	Min.	Max.	Min.	Max.	
А	0.029	0.030	0.750	0.765	
В	0.015	0.016	0.380	0.395	
С	0.007	0.008	0.175	0.195	
D	0.004	0.005	0.101	0.127	
Е	0.007	0.0073	0.177	0.185	
F	0.018	0.019	0.457	0.482	



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## Electrical Specifications: T<sub>A</sub> = +25°C

Symbol	Parameter	Conditions	Units	Min	Тур	Мах
CT	Total Capacitance	-10 V, 1 MHz	pF	_	0.025	0.030
Rs	Series Resistance	10 mA, 1 GHz	Ω	—	5.2	7.0
V <sub>F</sub>	Forward Voltage	10 mA	V	—	1.33	1.45
I <sub>R</sub>	Reverse Leakage Current <sup>3</sup>	V <sub>R</sub> = -45 V	nA	_	_	50
T <sub>RISE</sub> / T <sub>FALL</sub>	Switching Speed <sup>4</sup>	10 GHz	ns	—	2	_

3. The max rated  $V_R$ (-45V) is sourced and the resultant reverse leakage current, Ir, is measured to be <50nA 4. Switching speed is measured between 10% and 90% or 90% to 10% RF voltage for a single series mounted diode. Driver delay is not included.

## Absolute Maximum Ratings: T<sub>A</sub> = 25°C

Parameter	Absolute Maximum	
Reverse Voltage	45V	
Operating Temperature	-55°C to +125°C	
Storage Temperature	-55°C to +150°C	
Junction Temperature	+175°C	
Dissipated Power (RF + DC)	100mW	
C.W. Incident Power	+23 dBm	
Mounting Temperature	+280°C for 10 seconds	

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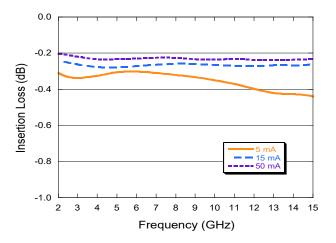


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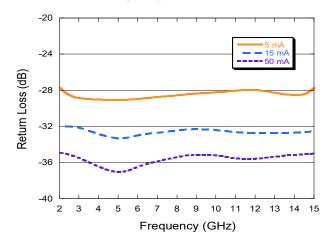
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## **Typical Performance Curves**

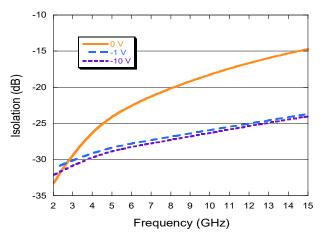
#### Insertion Loss vs. Frequency



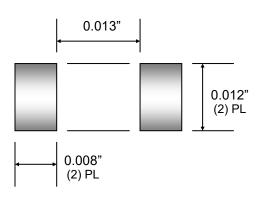
#### Return Loss vs. Frequency



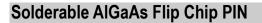
#### Isolation vs. Frequency



### **Circuit Pad Layout**



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### **Device Installation Guidelines**

#### Cleanliness

This device should be handled in a clean environment. The chip is resistant to solvents and may be cleaned using approved industry standard practices and chemicals.

#### **Static Sensitivity**

Aluminum Gallium Arsenide PIN diodes are ESD sensitive and can be damaged by static electricity. Proper ESD handling techniques should be used. These devices are rated Class 1A, (0-250 V) HBM.

#### **General Handling**

The die has a BCB, polymer layer which provides scratch protection for the junction area and the anode air bridge. Die can be handled with plastic tweezers or picked and placed with a #27 tip vacuum pencil.

#### Assembly Requirements using Electrically Conductive Silver Epoxy

The MADP-000907-14020 is designed to be inserted onto hard or soft substrates with the junction/pad side down. It may be mounted onto a silk-screened circuit using electrically conductive silver epoxy, approximately 1-2 mils in thickness and cured at approximately 90°C to 150°C per manufacturer's schedule. For extended cure times, >30 minutes, temperatures must be kept below 200°C.

#### **Eutectic Solder Die Attached**

63/37 Sn/Pb or any RoHS compliant solder may be used for diode attachment. It is recommended that the attachment surface be preheated to 100°C prior to re-flow in order to minimize CTE mismatches. Gradual temperature ramp up and ramp down is also recommended with a maximum soldering temperature of 280°C for less than 10 seconds. See **Application Note** <u>M538</u> for recommended soldering profile.

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